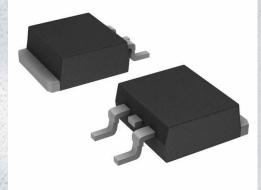


# NTD70N03RG Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	NTD70N03RG-DG
Manufacturer	onsemi
Manufacturer Product Number	NTD70N03RG
Description	MOSFET N-CH 25V 10A/32A DPAK
Detailed Description	N-Channel 25 V 10A (Ta), 32A (Tc) 1.36W (Ta), 62.5 W (Tc) Surface Mount DPAK

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# Purchase and inquiry

Manufacturer Dreduct Numbers	Manufacturori
Manufacturer Product Number:	Manufacturer:
NTD70N03RG	onsemi
Series:	Product Status:
	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
25 V	10A (Ta), 32A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4.5V, 10V	8mOhm @ 20A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2V @ 250µA	13.2 nC @ 5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1333 pF @ 20 V
FET Feature:	Power Dissipation (Max):
-	1.36W (Ta), 62.5W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 175°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
DPAK	TO-252-3, DPAK (2 Leads + Tab), SC-63
Base Product Number:	
NTD70	

# **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.29.0095

# NTD70N03R

# **Power MOSFET**

### 72 A, 25 V, N-Channel DPAK

#### Features

- Planar HD3e Process for Fast Switching Performance
- Low R<sub>DS(on)</sub> to Minimize Conduction Loss
- Low C<sub>ISS</sub> to Minimize Driver Loss
- Low Gate Charge
- Pb-Free Packages are Available

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C Unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage	V <sub>DSS</sub>	25	$V_{dc}$	
Gate-to-Source Voltage - Continuous	V <sub>GS</sub>	±20	$V_{dc}$	
Thermal Resistance - Junction-to-Case Total Power Dissipation @ T <sub>C</sub> = 25°C Drain Current	${\sf R}_{ heta JC} \ {\sf P}_{\sf D}$	2.4 62.5	°C/W W	
- Continuous @ $T_C = 25^{\circ}$ C, Chip - Continuous @ $T_C = 25^{\circ}$ C, Limited by Package - Continuous @ $T_A = 25^{\circ}$ C, Limited by Wires - Single Pulse ( $t_p = 10 \ \mu$ s)	I <sub>D</sub> I <sub>D</sub> I <sub>DM</sub>	72.0 62.8 32 140	A A A A	
Thermal Resistance - Junction-to-Ambient	$R_{\theta JA}$	80	°C/W	
Total Power Dissipation @ $T_A = 25^{\circ}C$ Drain Current – Continuous @ $T_A = 25^{\circ}C$	P <sub>D</sub> I <sub>D</sub>	1.87 12.0	W A	
Thermal Resistance - Junction-to-Ambient	$R_{\thetaJA}$	110	°C/W	
Total Power Dissipation @ $T_A = 25^{\circ}C$ Drain Current – Continuous @ $T_A = 25^{\circ}C$	P <sub>D</sub> I <sub>D</sub>	1.36 10.0	W A	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C	
Single Pulse Drain-to-Source Avalanche Energy – Starting T <sub>J</sub> = 25°C ( $V_{DD}$ = 30 V <sub>dc</sub> , V <sub>GS</sub> = 10 V <sub>dc</sub> , I <sub>L</sub> = 12 A <sub>pk</sub> , L = 1 mH, R <sub>G</sub> = 25 $\Omega$ )	E <sub>AS</sub>	71.7	mJ	
Maximum Lead Temperature for Soldering Purposes, 1/8" from Case for 10 s	ΤL	260	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. When surface mounted to an FR4 board using 0.5 sq. in. pad size.

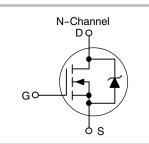
When surface mounted to an FR4 board using minimum recommended pad size.



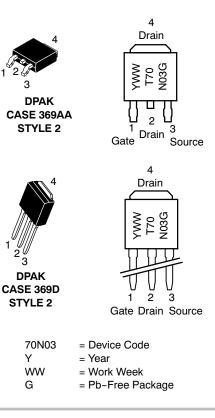
#### **ON Semiconductor®**

#### http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> TYP	I <sub>D</sub> MAX
25 V	$5.6~\mathrm{m}\Omega$	72 A



#### MARKING DIAGRAMS



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

#### NTD70N03RG onsemi MOSFET N-CH 25V 10A/32A DPAK

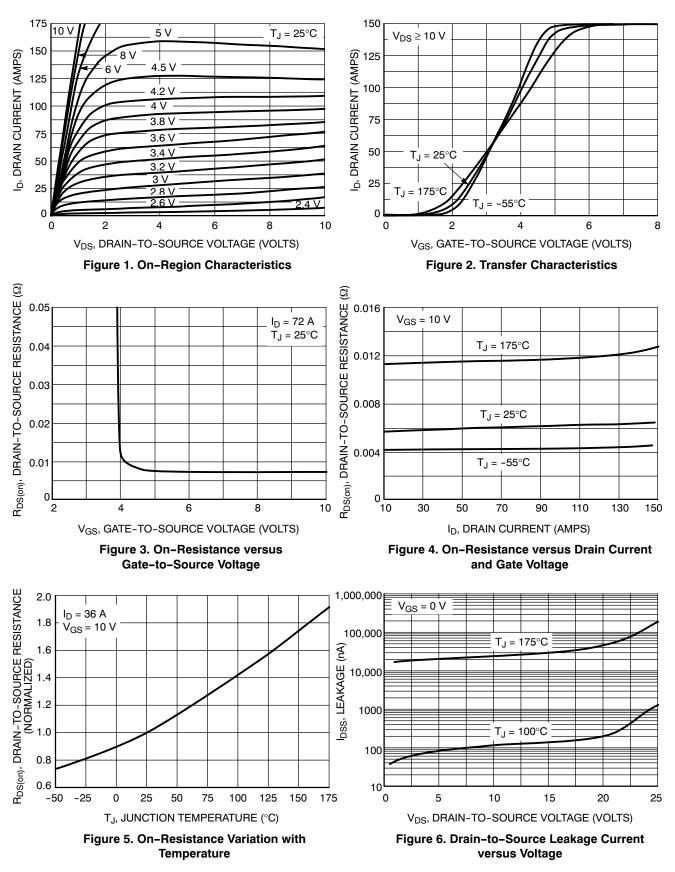
#### **NTD70N03R**

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C Unless otherwise specified)

C	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage (Note 3) ( $V_{GS} = 0 V_{dc}$ , $I_D = 250 \mu A_{dc}$ ) Temperature Coefficient (Positive)		V <sub>(br)DSS</sub>	25 -	28 20.5		V <sub>dc</sub> mV/°C
Zero Gate Voltage Drain Cur	dc)	I <sub>DSS</sub>	-		1.5 10	μA <sub>dc</sub>
Gate-Body Leakage Current ( $V_{GS} = \pm 20 V_{dc}, V_{DS} = 0 V_{dc}$		I <sub>GSS</sub>	-	_	±100	nA <sub>dc</sub>
ON CHARACTERISTICS (No	ote 3)					
Gate Threshold Voltage (Not $(V_{DS} = V_{GS}, I_D = 250 \ \mu A_d$ Threshold Temperature Coef	c)	V <sub>GS(th)</sub>	1.0 -	1.5 4.0	2.0 -	V <sub>dc</sub> mV/°C
Static Drain-to-Source On-H $(V_{GS} = 4.5 V_{dc}, I_D = 20 A_d)$ $(V_{GS} = 10 V_{dc}, I_D = 20 A_d)$	dc)	R <sub>DS(on)</sub>		8.1 5.6	13 8.0	mΩ
Forward Transconductance ( $(V_{DS} = 10 V_{dc}, I_D = 15 A_d)$	,	<b>9</b> FS	-	27	-	Mhos
DYNAMIC CHARACTERIST	ICS			•		
Input Capacitance		C <sub>ISS</sub>	-	1333	-	pF
Output Capacitance	$(V_{DS} = 20 V_{dc}, V_{GS} = 0 V, f = 1 MHz)$	C <sub>OSS</sub>	-	600	-	
Transfer Capacitance		C <sub>RSS</sub>	-	218	-	
SWITCHING CHARACTERIS	STICS (Note 4)					
Turn-On Delay Time		t <sub>d(on)</sub>	-	6.9	-	ns
Rise Time	(V <sub>GS</sub> = 10 V <sub>dc</sub> , V <sub>DD</sub> = 10 V <sub>dc</sub> ,	t <sub>r</sub>	-	1.3	-	
Turn-Off Delay Time	$I_{\rm D} = 36  A_{\rm dc},  R_{\rm G} = 3  \Omega)$	t <sub>d(off)</sub>	-	18.4	-	
Fall Time	1	t <sub>f</sub>	-	5.5	-	
Gate Charge		QT	-	13.2	-	nC
	$(V_{GS} = 5 V_{dc}, I_D = 36 A_{dc}, V_{DS} = 10 V_{dc})$ (Note 3)	Q <sub>GS</sub>	-	3.3	-	1
		Q <sub>DS</sub>	-	6.5	-	
SOURCE-DRAIN DIODE CH	IARACTERISTICS			•		
Forward On-Voltage	$      (I_S = 20 \ A_{dc}, \ V_{GS} = 0 \ V_{dc}) \ (Note \ 3) \\       (I_S = 20 \ A_{dc}, \ V_{GS} = 0 \ V_{dc}, \ T_J = 125^\circ C) $	V <sub>SD</sub>	-	0.86 0.73	1.2 -	V <sub>dc</sub>
Reverse Recovery Time	1	t <sub>rr</sub>	-	27.9	-	ns
		t <sub>a</sub>	-	14.8	-	
	$(I_{S} = 36 A_{dc}, V_{GS} = 0 V_{dc}, dI_{S}/dt = 100 A/\mu s)$ (Note 3)	t <sub>b</sub>	-	13.1	-	
Reverse Recovery Stored Charge	1	Q <sub>RR</sub>	-	19	-	nC

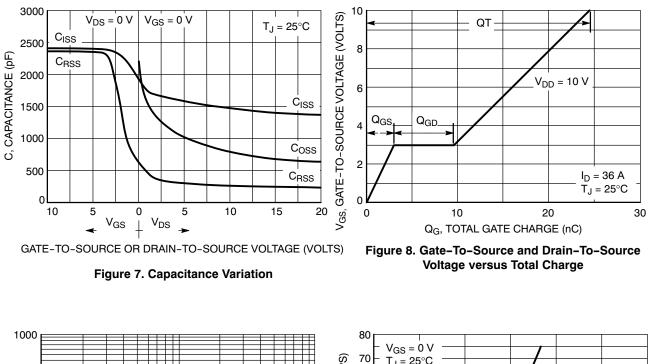
Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%.
Switching characteristics are independent of operating junction temperatures.

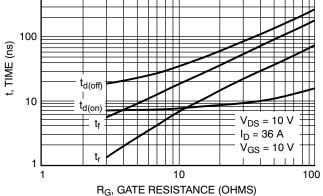
#### NTD70N03R

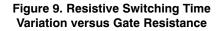


#### TYPICAL PERFORMANCE CURVES (T<sub>J</sub> = 25°C unless otherwise noted)









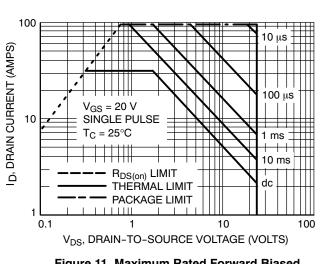


Figure 11. Maximum Rated Forward Biased Safe Operating Area

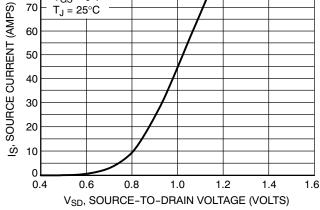
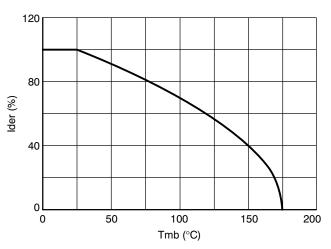


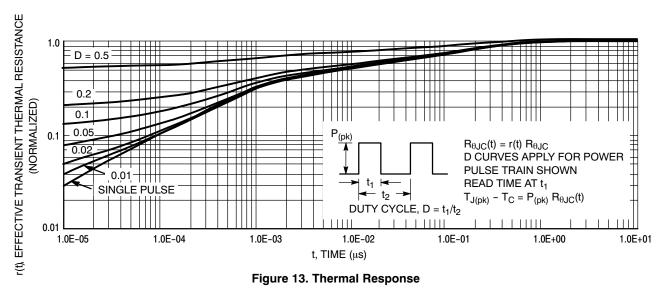
Figure 10. Diode Forward Voltage versus Current





#### NTD70N03RG onsemi MOSFET N-CH 25V 10A/32A DPAK

NTD70N03R



#### **ORDERING INFORMATION**

Order Number	Package	Shipping <sup>†</sup>
NTD70N03R	DPAK-3	75 Units / Rail
NTD70N03RG	DPAK-3 (Pb-Free)	75 Units / Rail
NTD70N03RT4	DPAK-3	2500 / Tape & Reel
NTD70N03RT4G	DPAK-3 (Pb-Free)	2500 / Tape & Reel
NTD70N03R-1	DPAK-3 Straight Lead	75 Units / Rail
NTD70N03R-1G	DPAK-3 Straight Lead (Pb-Free)	75 Units / Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



**MECHANICAL CASE OUTLINE** 

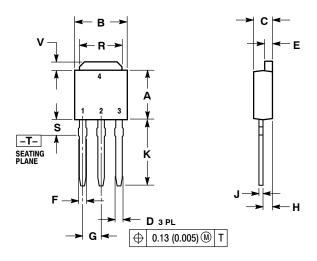
PACKAGE DIMENSIONS



DPAK INSERTION MOUNT CASE 369 ISSUE O

DATE 02 JAN 2000





			DN: INCH	
		HES		ETERS
DIM	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
Е	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.090	BSC	2.29 BSC	
Η	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.175	0.215	4.45	5.46
S	0.050	0.090	1.27	2.28
v	0.030	0.050	0.77	1.27

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

MT1
MT2
GATE
MT2
1. 2. 3. 1.

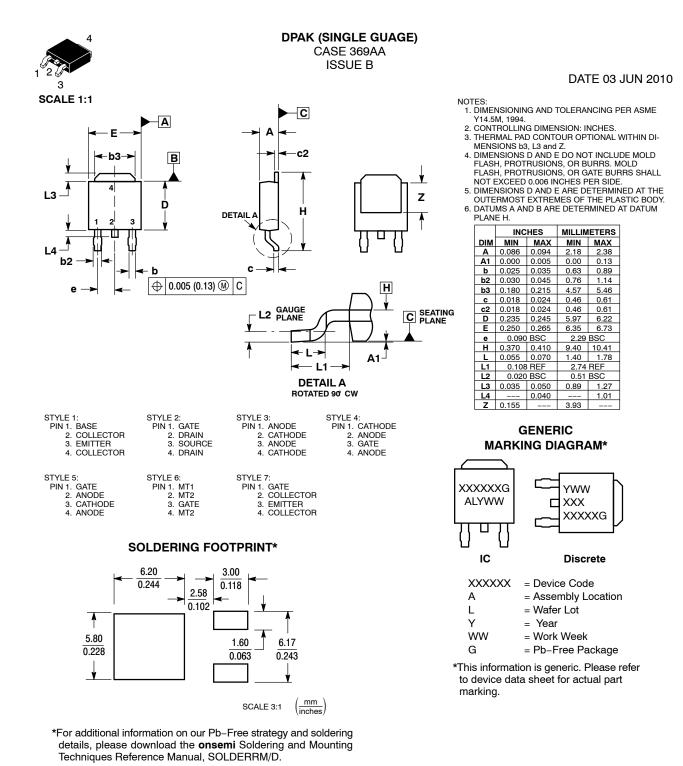
DOCUMENT NUMBER:	98ASB42319B Electronic versions are uncontrolled except when accessed directly from the Document Rep Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	DPAK INSERTION MOUNT		PAGE 1 OF 1

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**MECHANICAL CASE OUTLINE** 

PACKAGE DIMENSIONS



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